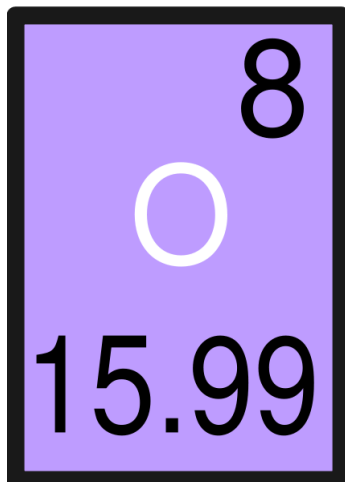
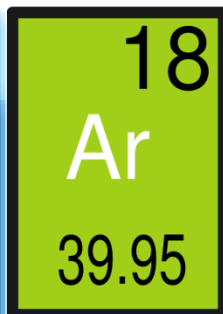
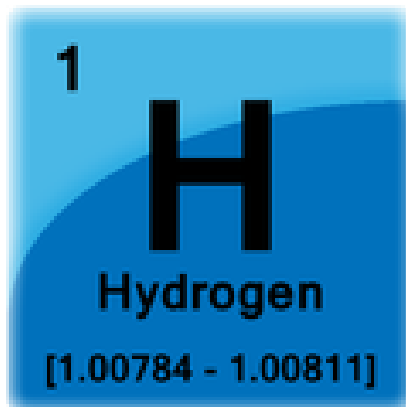


Oxygen & Hydrogen Low-Pressure RF Plasma Cleaning

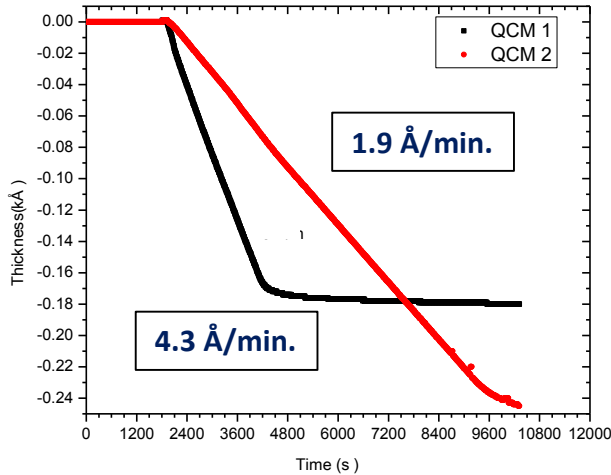


&



O₂ Plasma Cleaning of Test Mirror as Provided by SSRF

Carbon thickness as a function of time:

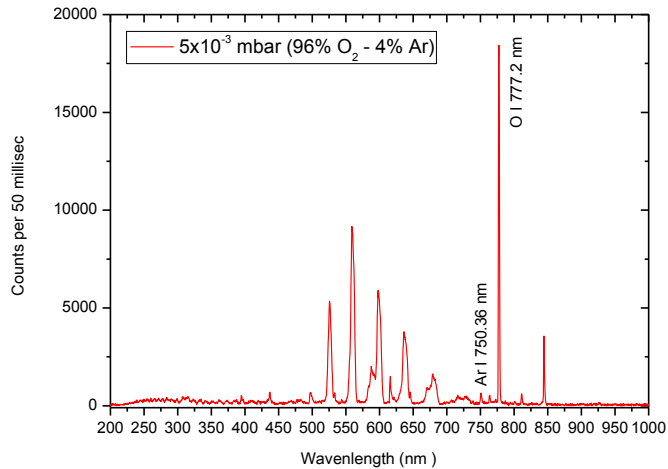


⇒ Fast & safe carbon contamination cleaning



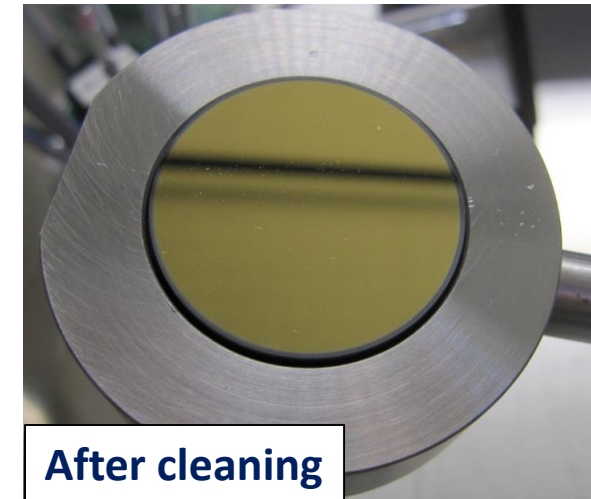
Before cleaning

Optical emission from O₂/Ar plasma:



⇒ Neutral O[•] radicals as chemically active species

⇒ Neutral H[•] radicals for H₂ plasma.

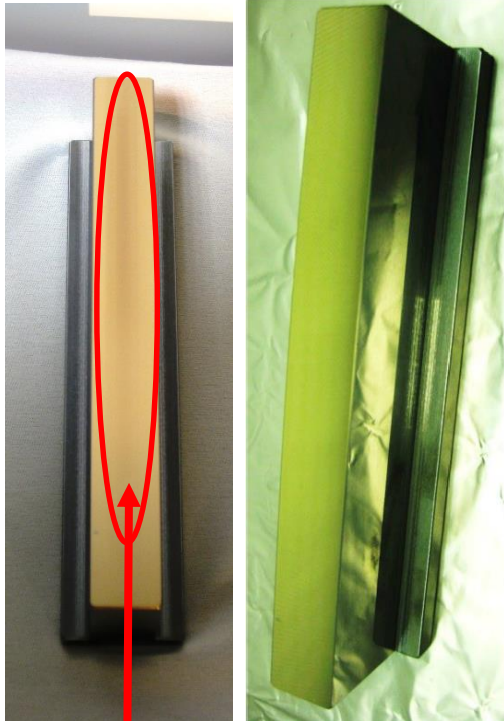


After cleaning

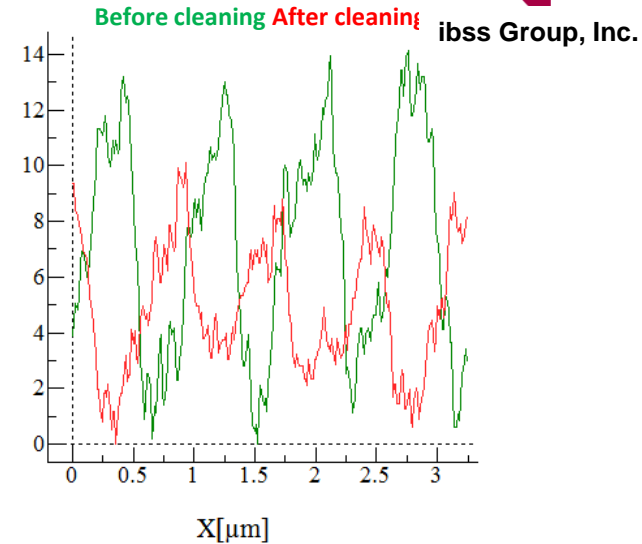
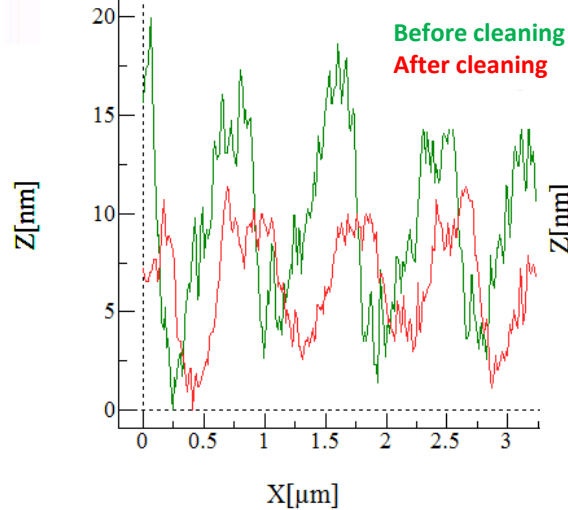
1200 l/mm, 0.85° blaze angle, plane Si blank, 35 nm Au coating, no Cr buffer layer.

AFM scans of grating profile:

Before cleaning: After cleaning:

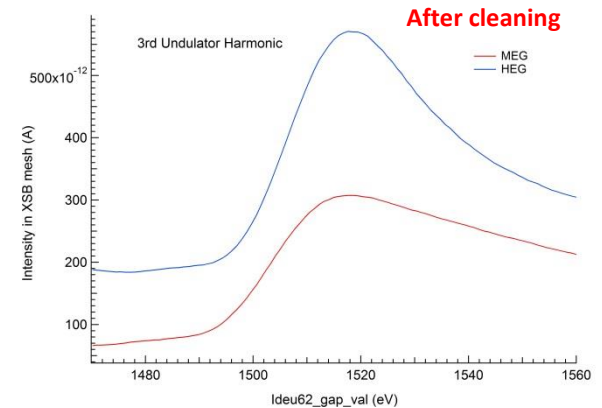
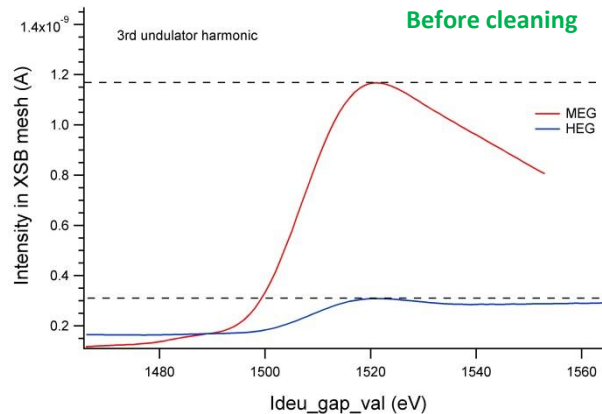


Photon beam footprint with C contamination trace.



👉 Recovery of “as-delivered” blazed grating profile.

Photon flux measurements downstream exit slit:



👉 Increase of grating efficiency by factor of 7.6 by cleaning.

Results from RF Plasma Cleaning with GV10x

- Quantitative results for optimum cleaning rates.
- GV10x gun with better performance than “classical” capacitive RF antenna gun.
- O₂/Ar plasma good choice for Au surfaces (fast & safe)
- H₂/Ar/Ne plasma good choice for Ni and Rh (slower, but non-oxidizing)
- Blank Si surfaces tricky to clean.

Other results:

- Cleaning of high-energy grating of Circe soft x-ray beamline with full recovery of grating profile and performance.
- Up-scaling of in-situ cleaning process to realistic large UHV mirror systems.